

Final Product Change Notification

202306009F01: DIE ATTACH GLUE CHANGE DUE TO HENKEL 8388A DISCONTINUATION

Note: This notice is NXP Company Proprietary.

Issue Date: Sep 22, 2023 Effective date:Dec 21, 2023

Dear DigiKey Supplier Info PCNs,

Here is your personalized notification about a NXP general announcement. For detailed information we invite you to view this notification online

Management summary

For all Sales Items of MOA4 and MOA8 modules the used die attached glue Henkel LOCTITE ABLESTIK 8388A will change to Henkel LOCTITE ABLESTIK QMI550.

The existing die attach glue has been discontinued by our supplier in December 2022. NXP could arrange enough die attach glue to be able to produce until December 2023.

From January 2024 onwards the new die attach glue will be used in production after depletion of the existing glue stock.

The new die attach glue has been carefully selected together with Henkel LOCTITE ABLESTIK ABP 2035SCR to enhance the overall performance and durability of the product for qualifications. Out of qualification Henkel LOCTITE ABLESTIK QMI550 turned out to be the glue of choice to release to production.

Change Category

j	[]Wafer Fab Process	[X]Assembly Process	[]Product Marking	[]Test Process	[]Design
İ	[]Wafer Fab Materials	[X]Assembly Materials	[]Mechanical Specification	[]Test Equipment	[]Errata
İ	∐Wafer Fab ∟ocation	[]Assembly Location	[]Packing/Shipping/Labeling	[]Test Location	[]Electrical spec./Test coverage
	[]Firmware	[]Other			

PCN Overview

Description

The die attach glue used between the chip and lead frame in chip on lead frame packaging serves as a bonding material to securely attach the chip to the lead frame. This die attach adhesive is changed from Henkel LOCTITE ABLESTIK 8388A to Henkel LOCTITE ABLESTIK QMI550 for all MOA4 and MOA8 modules.

There are no changes to the form, fit and function of the MOA4 and MOA8 modules due to the changeover to the new die attach glue from the same supplier.

The revised module continues to offer the same high-quality performance and reliability standards.

Attached to this notification, you will find the Qualification Report which outlines the qualification results and criteria for the revised modules.

Reason

The existing die attach glue has been discontinued by our supplier in December 2022. NXP could arrange enough die attach glue to be able to produce until December 2023.

The new qualified die attach glue from Henkel LOCTITE ABLESTIK QMI550 will be used in production after depletion of the existing stock of Henkel LOCTITE ABLESTIK 8388A.

Identification of Affected Products

Product identification does not change

Product Availability

Sample Information

Samples are available upon request

Production

Planned first shipment

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No Impact on form, fit, function, reliability or quality

Data Sheet Revision

No impact to existing datasheet

Disposition of Old Products

Existing inventory will be shipped until depleted

Additional information

Self qualification:view online

Timing and Logistics

In compliance with JEDEC J-STD-046, your acknowledgement of this change is expected by Oct 22, 2023.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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NXP Quality Management Team.

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Orderable PN#	_				_	Product Status	
MF0UL2101DA8,118 MF3D43C0DA4/001	935405168118	MF3D43C0DA4/00		CLM2M	SOT500-2	RFS RFS	BLT1 BLT1
MF3D83C0DA4/00J MF1P4220DA8/00TGJ	935419789118	MF1P4220DA8/00TG	CTHM	CLM2M	SOT500-4	RFS RFS	BLT1 BLT1
MF1P2200DA8/00MOJ MF1P4230DA4/00J	935404438118		анм	CLM2M	SOT500-2	RFS RFS	BLT1 BLT1
MF1P4230DA8/001 MF3D4300DA8/001	935388158118	MF3D4300DA8/00	анм	CLM2M	SOT500-4	RFS RFS	BLT1 BLT1
MF3D23C0DA8/001 MF3DH8300DA4/001	935402533118	MF3DH8300DA4/00	анw	CLM2M	SOT500-2	RFS RFS	BLT1 BLT1
MF3DH8300DA8/00J MF1P2230DA8/00J	-			CLM2M		RFS RFS	BLT1 BLT1
MF1PH2200DA8/00J MF1PH4200DA4/00J				CLM2M CLM2M		RFS RFS	BLT1 BLT1
MF1PH4200DA8/001 MF3D4300DA4/001	_			CLM2M CLM2M		RFS RFS	BLT1 BLT1
MF3DH2300DA8/001 MF3DH4300DA8/001	-			CLM2M CLM2M		RFS RFS	BLT1 BLT1
MF3DH43C0DA8/00J MF1PH2230DA8/00J		-		CLM2M CLM2M		RFS RFS	BLT1 BLT1
MF3D2300DA4/00J MF3DH83C0DA8/00J	_	· .		CLM2M CLM2M		RFS RFS	BLT1 BLT1
MF3DH2300DA4/00J MF3DH3300DA4/00J		MF3DH2300DA4/00	анм	CLM2M CLM2M	SOT500-2	RFS RFS	BLT1 BLT1
MF3DH23C0DA4/00J MF3DH43C0DA4/00J	935405202118	MF3DH23C0DA4/00	анм	CLM2M	SOT500-2	RFS RFS	BLT1 BLT1
MF1PH4230DA8/001 MF1PH4230DA4/001	935405061118	MF1PH4230DA8/00	анw	CIM2M CIM2M	SOT500-4	RFS RFS	BLT1 BLT1
MF1P4200DA8/00MOJ MF3D2300DA8/00J	935405845118	MF1P4200DA8/00MO	анм	CLM2M CLM2M	SOT500-4	RFS RFS	BLT1 BLT1
MF3DH83C0DA4/00J MF1PH2230DA4/00J	935405208118	MF3DH83C0DA4/00	анw	CIM2M CIM2M	SOT500-2	RFS RFS	BLT1 BLT1
MF3D83C0DA8/00J	935405069118	MF3D83C0DA8/00	анw	CIM2M CIM2M	SOT500-4	RFS	BLT1
MF3DH23C0DA8/00J MF1P4200DA8/00J	935404786118	MF1P4200DA8/00	анм	СІМ2М	SOT500-4	RFS RFS	BLT1 BLT1
MF1P4200DA4/00J MF1P2200DA4/00J	935404211118	MF1P2200DA4/00	CTHM	CLM2M		RFS RFS	BLT1 BLT1
MF1P2200DA8/00J MF1PH2200DA4/00J	935405183118	MF1PH2200DA4/00	CTHAN CTHAN	CLM2M	SOT500-2	RFS RFS	BLT1 BLT1
MF1P4220DA4/00TGJ MF3D8300DA4/00J			CTHM CTHM	CLM2M		RFS RFS	BLT1 BLT1
MF3D8300DA8/00J MF1P2230DA4/00J	935402951118	MF1P2230DA4/00	CTHM CTHM	CLM2M CLM2M	SOT500-2	RFS RFS	BLT1 BLT1
MF3D23C0DA4/001 MF3D43C0DA8/001	935405172118	MF3D43C0DA8/00	CTHM CTHM	CLM2M CLM2M		RFS RFS	BLT1 BLT1
MF2DLH1000DA8/021 MF0AES2000DA81		-	CTHM CTHM	CLM2M CLM2M		RFS RFS	BLT1 BLT1
MF0AESH2000DA8J MF2DL1000DA4/02J		_	CTHM CTHM	CLM2M CLM2M		RFS RFS	BLT1 BLT1
MF2DLH1000DA4/02J NT2H1311G0DA8J		-	CLHW NFC Tags	CLM2M CLM2M		RFS DOD	BLT1 BLT1
NT2H1511G0DA81 NT2H1611G0DA81	935304625118	NT2H1511G0DA8	NFC Tags	СІМ2М	SOT500-4	DOD DOD	BLT1 BLT1
MF1SPLUS8001DA4/03 MF1SPLUS6031DA8/03	935290189118	MF1SPLUS8001DA4/03 MF1SPLUS6031DA8/03	анм	CLM2M CLM2M	SOT500-2	RFS RFS	BLT1 BLT1
MF1SPLUS8031DA8/03 NT4H2421G0DA8/021	935294394118	MF1SPLUS8031DA8/03		CIM2M CIM2M	SOT500-4	RFS RFS	BLT1
OM6724,118	935280453118	OM6724	MOB4 DUI	СІМ2М	SOT500-2	DOD	BLT1 BLT1
SL2S2602FA8J OM6728,118	935308352118 935293962118	OM6728	CLHW CLHW	CLM2M	SOT500-4	DOD RFS	BLT1 BLT1
MF3MODQ101DA8/06J MF3MODHQ101DA8/06J	935307858118		анм	CLM2M	SOT500-4	RFS RFS	BLT1 BLT1
MF1PLUS8031DA4/03, MF1PLUS6031DA4/03,		MF1PLUS8031DA4/03 MF1PLUS6031DA4/03		CLM2M		RFS RFS	BLT1 BLT1
MF1SPLUS6031DA4/03 MF1SPLUS8031DA4/03		MF1SPLUS6031DA4/03 MF1SPLUS8031DA4/03		CLM2M CLM2M		RFS RFS	BLT1 BLT1
MF3MOD8101DA4/05,1 MF3MOD4101DA4/05,1				CLM2M CLM2M		RFS RFS	BLT1 BLT1
MF3MOD2101DA4/05,1 MF0MOU2001DA8,118		-		CLM2M CLM2M		RFS RFS	BLT1 BLT1
MF3MODH8101DA4/05, MF3MODH4101DA4/05,				CLM2M CLM2M		RFS RFS	BLT1 BLT1
MF3MODH2101DA4/05, MF1SPLUS6001DA8/03		MF3MODH2101DA4/0: MF1SPLUS6001DA8/03		CLM2M CLM2M		RFS RFS	BLT1 BLT1
MF1SPLUS8001DA8/03 MF1PLUS6001DA8/03,		MF1SPLUS8001DA8/03 MF1PLUS6001DA8/03		CLM2M CLM2M		RFS RFS	BLT1 BLT1
MF1PLUS6031DA8/03, MF1PLUS8001DA8/03,		MF1PLUS6031DA8/03 MF1PLUS8001DA8/03		CLM2M CLM2M		RFS RFS	BLT1 BLT1
MF1PLUS8031DA8/03, MF3MOD8101DA8/05,1		MF1PLUS8031DA8/03 MF3MOD8101DA8/05		CLM2M CLM2M		RFS RFS	BLT1 BLT1
MF3MOD4101DA8/05,1 MF3MOD2101DA8/05,1	935294662118	MF3MOD4101DA8/05	анм	CLM2M CLM2M	SOT500-4	RFS RFS	BLT1 BLT1
MF3MODH8101DA8/05, MF3MODH4101DA8/05,	935294665118	MF3MODH8101DA8/0:	анw	CLM2M CLM2M	SOT500-4	RFS RFS	BLT1 BLT1
MF3MODH2101DA8/05, MF0MOU2101DA8.118	935294667118	MF3MODH2101DA8/0:		CLM2M CLM2M	SOT500-4	RFS RFS	BLT1 BLT1
MF3MOD4101DA4/0501 MF1PLUS6021DA4/03J	935298406118		анw	CLM2M CLM2M	SOT500-2	RFS RFS	BLT1 BLT1
MF1S5000XDA4/V1J	935302816118	MF1S5000XDA4/V1	MIFARE	СІМ2М	SOT500-2	RFS	BLT1
MF1S5030XDA4/V11 MF1S7000XDA4/V11	935302822118	MF1S7000XDA4/V1	MIFARE	CLM2M	SOT500-2	RFS RFS	BLT1 BLT1
MF1S7030XDA4/V11 MF1S5000XDA8/V11	935302824118	MF1S5000XDA8/V1	MIFARE MIFARE	CLM2M	SOT500-4	RFS RFS	BLT1 BLT1
MF1S5030XDA8/V11 MF1S7000XDA8/V11	935302828118	MF1S7000XDA8/V1	MIFARE MIFARE	CLM2M	SOT500-4	RFS RFS	BLT1 BLT1
MF1S7030XDA8/V11 HT1MOA4S30/E/31	935303944118	HT1MOA4S30/E/3	MIFARE HITAG	CLM2M		RFS RFS	BLT1 BLT1
HT2MOA4S20/E/3/RI HTSMOH5602EVJ	935303947118	HTSMOH5602EV	HITAG HITAG	CLM2M CLM2M	SOT500-2	RFS DOD	BLT1 BLT1
HTSMOH4802EVJ MF1SEPH1001DA4/03J	935331367118	MF1SEPH1001DA4/03		CLM2M CLM2M	SOT500-2	DOD RFS	BLT1 BLT1
MF1SEPH1001DA8/031 MF1SEPH1031DA4/031		MF1SEPH1001DA8/03 MF1SEPH1031DA4/03		CLM2M CLM2M		RFS RFS	BLT1 BLT1
MF1SPLUS6001DA4/03	935290196118	MF1SPLUS6001DA4/03		CLM2M CLM2M	SOT500-2	RFS RFS	BLT1 BLT1
MF1PLUS8001DA4/03, MF1PLUS6001DA4/03,		MF1PLUS8001DA4/03 MF1PLUS6001DA4/03		CLM2M CLM2M		RFS RFS	BLT1 BLT1
MF3D2200DA4/01J MF3D4200DA4/01J		-	CTHM CTHM	CLM2M CLM2M		DOD DOD	BLT1 BLT1
MF3D8200DA4/011 MF3DH2200DA4/011		-	CTHM CTHM	CLM2M CLM2M	SOT500-2 SOT500-2	DOD DOD	BLT1 BLT1
MF3DH4200DA4/01J MF3DH8200DA4/01J	935347662118	MF3DH4200DA4/01	CTHM	CLM2M CLM2M	SOT500-2	DOD DOD	BLT1 BLT1
MF1SEP1001DA4/031 MF1SEP1001DA8/031	935306162118	MF1SEP1001DA4/03	CTHM	CLM2M CLM2M	SOT500-2	RFS RFS	BLT1 BLT1
MF1SEP1031DA4/031 MF1SEP1031DA8/031	935306172118	MF1SEP1031DA4/03	CTHM CTHM	CLM2M CLM2M	SOT500-2	RFS RFS	BLT1 BLT1
MF3D8200DA4/11J MF2DL1000DA8/62J	935384813118	MF3D8200DA4/11	анм	CLM2M CLM2M	SOT500-2	DOD RFS	BLT1 BLT1
MF3MODQ101DA4/06J MF1SEPH1031DA8/03J	935307405118	MF3MODQ101DA4/06 MF1SEPH1031DA8/03	анw	CLM2M CLM2M	SOT500-2	RFS RFS	BLT1 BLT1
MF3D9300DA8/011 MF3DH9300DA4/011	935453545118	MF3D9300DA8/01	анw	CLM2M CLM2M	SOT500-4	CQS CQS	BLT1 BLT1
MF3DF9300DA4/011 MF3DF9300DA8/011	935453542118	MF3D9300DA4/01	анм	СІМ2М	SOT500-2	cos	BLT1 BLT1
MF0MOA4U10/D,118	935281785118	MF6MOA4U16/D	анм	CIM2M CIM2M	SOT500-2	WIT ORS	BLT1
MF9MOA2001DA8J CLC/MF2DL1000DA8Z	935387576597	CLC/MF2DL1000DA8	CLHW SMART CA		SOT500-4 SOT500-4	OBS OBS	BLT1 BLT1
MF1P2101DA4/021 MF1P2111DA4/02SI	935377827118	MF1P2111DA4/02S	CTHM	CLM2M	SOT500-2	DOD DOD	BLT1 BLT1
MF1P2131DA4/021 MF1PH2131DA4/021	935360786118	MF1PH2131DA4/02	CTHM CTHM	CLM2M CLM2M	SOT500-2	DOD DOD	BLT1 BLT1
MF1PH2101DA4/02J MF1P4111DA4/02SJ	935378716118	MF1P4111DA4/02S	CTHM CTHM	CLM2M CLM2M	SOT500-2 SOT500-2	DOD DOD	BLT1 BLT1
MF1P4131DA4/021 MF1PH4101DA4/021			CTHM CTHM	CLM2M CLM2M	SOT500-2 SOT500-2	DOD DOD	BLT1 BLT1
MF1PH4131DA4/02J P308GMI3A4/T0CD20J	935360788118		анм	CLM2M CLM2M	SOT500-2 SOT500-2	DOD DOD	BLT1 BLT1
P304P11OA4/T0K09A1 P304D217A4/T0K09P1	935353799118	P304P11OA4/T0K09AE P304D217A4/T0K09PG	анм	CLM2M CLM2M	SOT500-2	DOD DOD	BLT1 BLT1
MF1S5000XDA4/V2I MF1S5030XDA4/V2I	935387922118	MF1S5000XDA4/V2	MIFARE MIFARE	CIM2M CIM2M	SOT500-2	DOD	BLT1 BLT1
MF1S5000XDA8/V2I MF1S5030XDA8/V2I	935387923118	MF1S5000XDA8/V2	MIFARE MIFARE	CLM2M CLM2M	SOT500-4	DOD	BLT1 BLT1
MF1P4101DA4/02I	935360475118	MF1P4101DA4/02	анw	СІМ2М	SOT500-2	DOD	BLT1
MF1S2030XDA4/V1	353302821118	MF1S2030XDA4/V1	MIFARE	СІМ2М	SOT500-2	DOD	BLT1